LNJ211R8ARA

Surface Mounting Chip LED

3216 Type

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol Rati		Unit	
Power dissipation	P_{D}	60	mW	
Forward current	I_{F}	20	mA	
Pulse forward current *	I_{FP}	100	mA	
Reverse voltage	V _R	3	V	
Operating ambient temperature	T _{opr}	-30 to +85	°C	
Storage temperature	T _{stg}	-40 to +100	°C	

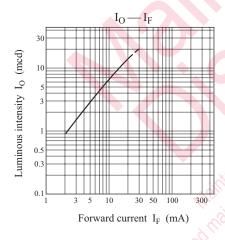
Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

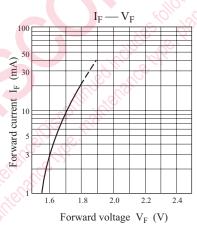
• Red

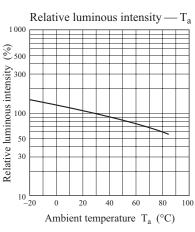
■ Lighting Color

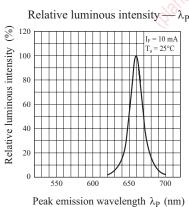
■ Electro-Optical Characteristics $T_a = 25$ °C

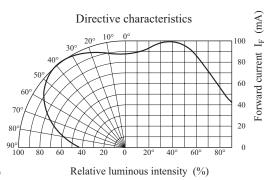
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Parameter	Symbol		Conditions	Min	Тур	Max	Unit
Luminous intensity	I _O	$I_F = 10 \text{ mA}$		2.3	7.0	5	mcd
Reverse current	I _R	$V_R = 3 \text{ V}$		(10 ^t)	7160,	100	μΑ
Forward voltage	$V_{\rm F}$	$I_F = 10 \text{ mA}$		100,100	1.72	2.5	V
Peak emission wavelength	$\lambda_{ m P}$	$I_F = 10 \text{ mA}$, our	dillo	660		nm
Spectral half band width	Δλ	$I_F = 10 \text{ mA}$	19 ji Q _{11i}	30,	20		nm

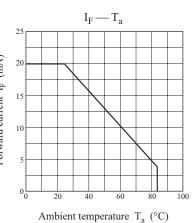








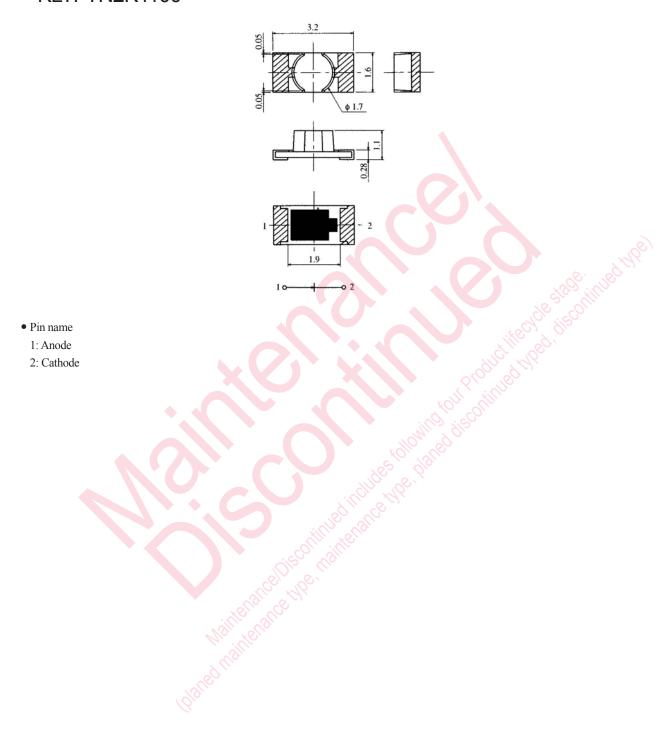




LNJ211R8ARA Panasonic

■ Package (Unit: mm)

KLTFTN2K1100



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